

EL7158

Ultra-High Current Pin Driver

FN7349 Rev 2.00 May 14, 2007

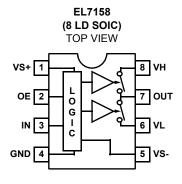
The EL7158 high performance pin driver with three-state is suited to many ATE and level-shifting applications. The 12A peak drive capability makes this part an excellent choice when driving high capacitance loads.

The output pin OUT is connected to input pins VH or VL respectively, depending on the status of the IN pin. When the OE pin is active low, the output is placed in the three-state mode. The isolation of the output FETs from the power supplies enables VH and VL to be set independently, enabling level-shifting to be implemented. Related to the EL7155, the EL7158 adds a lower supply pin VS- and makes VL an isolated and independent input. This feature adds applications flexibility and improves switching response due to the increased enhancement of the output FETs.

This pin driver has improved performance over existing pin drivers. It is specifically designed to operate at voltages down to 0V across the switch elements while maintaining good speed and ON-resistance characteristics.

Available in the 8 Ld SOIC package, the EL7158 is specified for operation over the full -40°C to +85°C temperature range.

Pinout



Features

- · Clocking speeds up to 40MHz
- 12ns t_R/t_F at 2000pF C_{I OAD}
- · 0.2ns rise and fall times mismatch
- 0.5ns t_{ON}-t_{OFF} prop delay mismatch
- · 3.5pF typical input capacitance
- 12A peak drive
- Low ON-resistance of 0.5Ω
- · High capacitive drive capability
- · Operates from 4.5V to 12V
- · Pb-free plus anneal available (RoHS compliant)

Applications

- · ATE/burn-in testers
- · Level shifting
- · IGBT drivers
- · CCD drivers

Ordering Information

PART NUMBER	PART MARKING	PACKAGE	TAPE & REEL	PKG. DWG. #
EL7158IS	7158IS	8 Ld SOIC	-	MDP0027
EL7158IS-T7	7158IS	8 Ld SOIC	7"	MDP0027
EL7158IS-T13	7158IS	8 Ld SOIC	13"	MDP0027
EL7158ISZ (Note)	7158ISZ	8 Ld SOIC (Pb-free)	-	MDP0027
EL7158ISZ-T7 (Note)	7158ISZ	8 Ld SOIC (Pb-free)	7"	MDP0027
EL7158ISZ-T13 (Note)	7158ISZ	8 Ld SOIC (Pb-free)	13"	MDP0027

NOTE: Intersil Pb-free products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which is compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J Std-020B.

Absolute Maximum Ratings $(T_A = +25^{\circ}C)$

Thermal Information

Storage Temperature Range	65°C to +150°C
Ambient operating Temperature	40°C to +85°C
Operating Junction Temperature	+125°C
Power Dissipation	see curves
Pb-free reflow profile	see link below
http://www.intersil.com/pbfree/Pb-FreeReflov	v.asp

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: $T_J = T_C = T_A$

Electrical Specifications V_S + = +12V, V_H = +12V, V_L = 0V, V_S - = 0V, T_A = +25°C, unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITION	MIN	TYP MAX		UNIT	
INPUT		-	l.				
V _{IH}	Logic '1' Input Voltage		2.4			V	
I _{IH}	Logic '1' Input Current	V _{IH} = V _S +		0.1	10	μA	
V _{IL}	Logic '0' Input Voltage				0.8	V	
I _{IL}	Logic '0' Input Current	V _{IL} = 0V		0.1	10	μA	
C _{IN}	Input Capacitance			3.5		pF	
R _{IN}	Input Resistance			50		ΜΩ	
OUTPUT	1	,	1	1	1		
R _{OVH}	ON-Resistance V _H to OUT	I _{OUT} = -500mA		0.5	1	Ω	
R _{OVL}	ON-Resistance V _L to OUT	I _{OUT} = +500mA		0.5	1	Ω	
lout	Output Leakage Current	OE = 0V, OUT = V _H /V _L		0.1	10	μA	
I _{PK}	Peak Output Current (linear resistive operation)	Source		12		Α	
		Sink		12		Α	
I _{DC}	Continuous Output Current	Source/Sink	500			mA	
POWER SUPPLY			1				
Is	Power Supply Current	Inputs = V _S +		1.3	3	mA	
I _{VH}	Off Leakage at V _H and V _L	V _H , V _L = 0V		4	10	μΑ	
SWITCHING CHA	RACTERISTICS		1				
t _R	Rise Time	C _L = 2000pF		12.0		ns	
t _F	Fall Time	C _L = 2000pF		12.2		ns	
$t_{RF\Delta}$	t _R , t _F Mismatch	C _L = 2000pF		0.2		ns	
t _{d-1}	Turn-Off Delay Time	C _L = 2000pF		22.5		ns	
t _{d-2}	Turn-On Delay Time	C _L = 2000pF		22.0		ns	
$t_{d\Delta}$	t _{d-1} -t _{d-2} Mismatch	C _L = 2000pF		0.5		ns	
t _{d-3}	Three-State Delay Enable			22		ns	
t_{d-4}	Three-State Delay Disable			22		ns	
SR+	V _{OUT} + Slew Rate	$R_{LOAD} = 6\Omega$		800		V/µs	
SR-	V _{OUT} - Slew Rate	$R_{LOAD} = 6\Omega$		800		V/µs	



$\textbf{Electrical Specifications} \hspace{0.5cm} V_S + = +12V, \hspace{0.1cm} V_H = +1.2V, \hspace{0.1cm} V_L = 0V, \hspace{0.1cm} V_{S^-} = 0V, \hspace{0.1cm} T_A = +25^{\circ}C, \hspace{0.1cm} \text{unless otherwise specified.} \hspace{0.1cm} \textbf{(Continued)} \\$

PARAMETER	DESCRIPTION	CONDITION	MIN	TYP	MAX	UNIT
INPUT	-	,	<u> </u>	1	l .	
V _{IH}	Logic '1' Input Voltage		2.0			V
lін	Logic '1' Input Current	V _{IH} = V _S +		0.1	10	μΑ
V _{IL}	Logic '0' Input Voltage				0.8	V
I _{IL}	Logic '0' Input Current	V _{IL} = 0V		0.1	10	μA
C _{IN}	Input Capacitance			3.5		pF
R _{IN}	Input Resistance			50		MΩ
OUTPUT			+	1	l	
R _{OVH}	ON-Resistance V _H to OUT	I _{OUT} = -500mA		0.5	1	Ω
R _{OVL}	ON-Resistance V _L to OUT	I _{OUT} = +500mA		0.5	1	Ω
lout	Output Leakage Current	OE = 0V, OUT = V _H /V _L		0.1	10	μA
I _{PK}	Peak Output Current (linear resistive operation)	Source		1.2		Α
		Sink		1.2		Α
I _{DC}	Continuous Output Current	Source/Sink	500			mA
POWER SUPPL	Υ			1	I	
Is	Power Supply Current	Inputs = V _S +		1	2.5	mA
V _H	Off Leakage at V _H and V _L	V _H , V _L = 0V		4	10	μA
SWITCHING CH	ARACTERISTICS		1	1	l .	
t _R	Rise Time	C _L = 2000pF		11		ns
t _F	Fall Time	C _L = 2000pF		11		ns
$t_{RF\Delta}$	t _R , t _F Mismatch	C _L = 2000pF		0		ns
t _{d-1}	Turn-Off Delay Time	C _L = 2000pF		20.5		ns
t _{d-2}	Turn-On Delay Time	C _L = 2000pF		20.0		ns
$t_{d\Delta}$	t _{d-1} -t _{d-2} Mismatch	C _L = 2000pF		0.5		ns
t _{d-3}	Three-State Delay Enable			20		ns
t _{d-4}	Three-State Delay Disable			20		ns
SR+	V _{OUT} + Slew Rate	$R_{LOAD} = 6\Omega$		80		V/µs
SR-	V _{OUT} - Slew Rate	$R_{LOAD} = 6\Omega$		80		V/µs

Typical Performance Curves

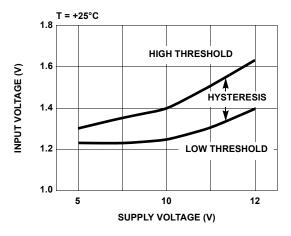


FIGURE 1. INPUT THRESHOLD vs SUPPLY VOLTAGE

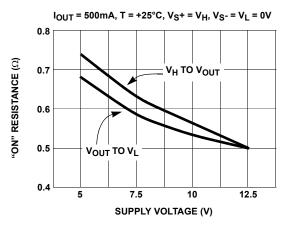


FIGURE 3. "ON"-RESISTANCE vs SUPPLY VOLTAGE (VS+)

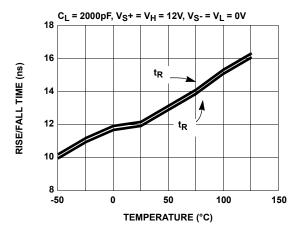


FIGURE 5. RISE/FALL TIME vs TEMPERATURE

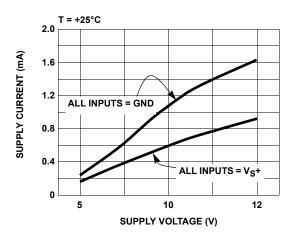


FIGURE 2. QUIESCENT SUPPLY CURRENT vs SUPPLY VOLTAGE

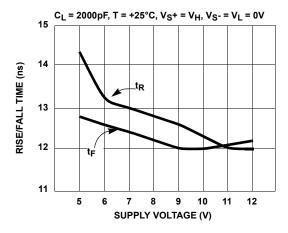


FIGURE 4. RISE/FALL TIME vs SUPPLY VOLTAGE

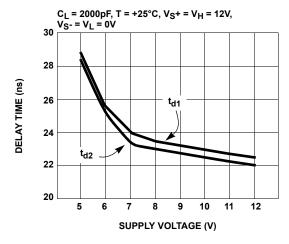


FIGURE 6. PROPAGATION DELAY vs SUPPLY VOLTAGE

Typical Performance Curves (Continued)

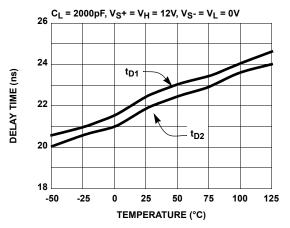


FIGURE 7. PROPAGATION DELAY vs TEMPERATURE

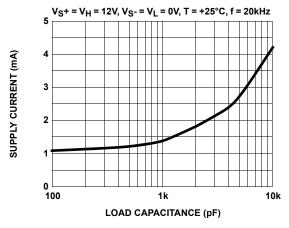


FIGURE 9. SUPPLY CURRENT vs LOAD CAPACITANCE

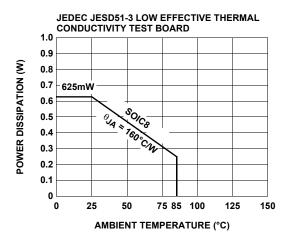


FIGURE 11. PACKAGE POWER DISSIPATION VS AMBIENT TEMPERATURE

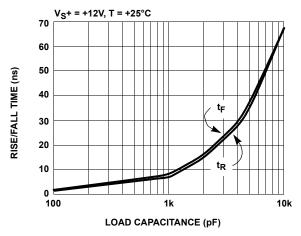


FIGURE 8. RISE/FALL TIME vs LOAD CAPACITANCE

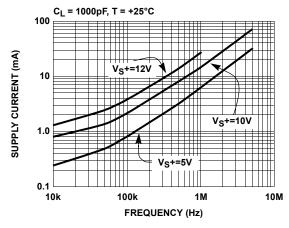


FIGURE 10. SUPPLY CURRENT vs FREQUENCY

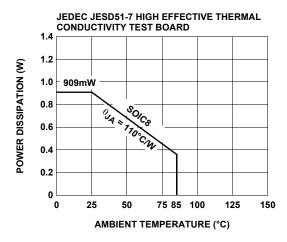


FIGURE 12. PACKAGE POWER DISSIPATION VS AMBIENT TEMPERATURE

TABLE 1. TRUTH TABLE

OE	IN	OUT
0	0	Three-State
0	1	Three-State
1	0	V _H
1	1	VL

TABLE 2. OPERATING VOLTAGE RANGE

PIN	MIN	MAX
V _S - to GND	-5	0
V _S + to V _S -	5	18
V _H to V _L	V _L 0 12	
V _S + to V _H	0	12
V _S + to GND	5	12
V _L to V _S -	0	12
Three-State Output	V_{L}	VH

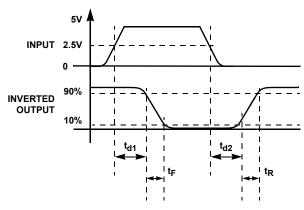


FIGURE 13. TIMING DIAGRAM

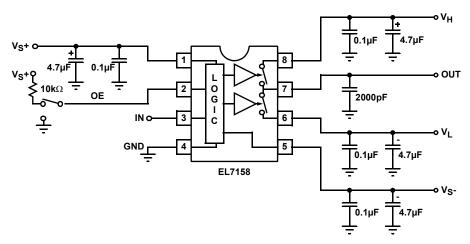


FIGURE 14. STANDARD TEST CONFIGURATION

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Pin Descriptions

PIN	NAME	FUNCTION	EQUIVALENT CIRCUIT
1	VS+	Positive Supply Voltage	
2	OE	Output Enable	INPUT O VS+0 VS-0 Circuit 1
3	IN	Input	Reference Circuit 1
4	GND	Ground	
5	VS-	Negative Supply Voltage	
6	VL	Lower Output Voltage	
7	OUT	Output	V _S -o
	1	T .	

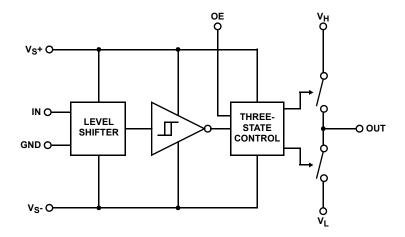


FIGURE 15. BLOCK DIAGRAM

Applications Information

Product Description

The EL7158 is a high performance 40MHz pin driver. It contains two analog switches connecting VH and VL to OUT. Depending on the value of the IN pin, one of the two switches will be closed and the other switch open. An output enable (OE) is also supplied which opens both switches simultaneously.

Due to the topology of the EL7158, both the VH and VL pins can be connected to any voltage between the VS+ and VS-pins, but VH must be greater than VL in order to prevent turning on the body diode at the output stage.

Three-State Operation

When the OE pin is low, the output is three-state (floating). The output voltage is the parasitic capacitance's voltage. It can be any voltage between VH and VL, depending on the previous state. At three-state, the output voltage can be pushed to any voltage between VH and $\rm V_L$. The output voltage can't be pushed higher than VH or lower than VL since the body diode at the output stage will turn on.

Supply Voltage Range and Input Compatibility

The EL7158 is designed for operation on supplies from 5V to 18V (4.5V to 18V maximum). Table 2 shows the specifications for the relationship between the VS+, VS-, VH, VL, and GND pins.

All input pins are compatible with both 3V and 5V CMOS signals. With a positive supply (V_S +) of 5V, the EL7158 is also compatible with TTL inputs.

Power Supply Bypassing

When using the EL7158, it is very important to use adequate power supply bypassing. The high switching currents developed by the EL7158 necessitate the use of a bypass capacitor between the supplies (V $_{\rm S}$ + and V $_{\rm S}$ -) and GND pins. It is recommended that a 2.2µF tantalum capacitor be used in parallel with a 0.1µF low-inductance ceramic MLC capacitor. These should be placed as close to the supply pins as possible. It is also recommended that the V $_{\rm H}$ and V $_{\rm L}$ pins have some level of bypassing, especially if the EL7158 is driving highly capacitive loads.

Power Dissipation Calculation

When switching at high speeds, or driving heavy loads, the EL7158 drive capability is limited by the rise in die temperature brought about by internal power dissipation. For reliable operation die temperature must be kept below T_{JMAX} (+125°C). It is necessary to calculate the power dissipation for a given application prior to selecting the package type.

Power dissipation may be calculated:

$$PD = (V_S \times I_S) + (C_{INT} \times {V_S}^2 \times f) + (C_L \times {V_{OUT}}^2 \times f)$$
 (EQ. 1)

where:

 V_S is the total power supply to the EL7158 (from V_S + to GND)

V_{OUT} is the swing on the output (V_H - V_L)

C_I is the load capacitance

C_{INT} is the internal load capacitance (100pF max)

Is is the quiescent supply current (3mA max)

f is frequency

Having obtained the application's power dissipation, a maximum package thermal coefficient may be determined, to maintain the internal die temperature below T_{JMAX}:

$$\theta_{JA} = \frac{T_{JMAX} - T_{MAX}}{PD}$$
 (EQ. 2)

where:

T_{JMAX} is the maximum junction temperature (+125°C)

T_{MAX} is the maximum operating temperature

PD is the power dissipation calculated above

 θ_{JA} thermal resistance on junction to ambient

 θ_{JA} is 160°C/W for the SOIC8 package when using a standard JEDEC JESD51-3 single-layer test board. If T_{JMAX} is greater than +125°C when calculated using Equation 2 , then one of the following actions must be taken:

Reduce θ_{JA} the system by designing more heat-sinking into the PCB (as compared to the standard JEDEC JESD51-3)

De-rate the application either by reducing the switching frequency, the capacitive load, or the maximum operating (ambient) temperature (T_{MAX})

